

BT138Y-800E

Rev.02- 26 May 2023

4Q Triac

Product data sheet

1. General description

Planar passivated sensitive gate four quadrant triac in an internally insulated IITO220 plastic package intended for use in general purpose bidirectional switching and phase control applications. This sensitive gate "series E" triac can be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits. The internally insulated mounting base gives good thermal performance combined with ease of handling and assembly by the user.

2. Features and benefits

- 2500 V RMS isolation voltage capability
- Direct interfacing to logic level ICs
- · Direct interfacing to low power gate drivers and microcontrollers
- High blocking voltage capability
- Industry standard TO220 package for ease of handling
- Isolated mounting base
- Planar passivated for voltage ruggedness and reliability
- Sensitive gate
- Triggering in all four quadrants

3. Applications

- 230 V lamp dimmers
- General purpose switching and phase control

4. Quick reference data

Table 1. Q	uick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	-	800	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; T _{mb} ≤ 85 °C; <u>Fig.1; Fig. 2</u> ; <u>Fig. 3</u>	-	-	12	A
I_{TSM}	non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p =20 ms; <u>Fig. 4; Fig. 5</u>	-	-	95	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p =16.7 ms	-	-	105	А
Tj	junction temperature		-	-	125	°C
Static ch	aracteristics		·			
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>	-	-	10	mA
		V _D = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u>	-	-	10	mA
		V _D = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u>	-	-	10	mA
		V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 7</u>	-	-	25	mA

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	30	mA
V _T	on-state voltage	I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.4	1.65	V
Dynamic characteristics							
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit		-	50	-	V/µs

5. Pinning information

Symbol	Description	Simplified outline	Graphic symbol
T1	main terminal 1	mb	NI
T2	main terminal 2		
G	gate		sym051
n.c.	mounting base; isolated		
	T1 T2 G	T1main terminal 1T2main terminal 2Ggate	T1 main terminal 1 T2 main terminal 2 G gate n.c. mounting base; isolated

6. Ordering information

Table 3. Ordering	information					
Type number	Package	Orderable part number	Packing	Small packing	Package	Package
	Name		method	quantity	version	issue date
BT138Y-800E	IITO220	BT138Y-800E,127	Tube	50	SOT78D (A)	10-July-2007
					IITO220P (P)	31-Mar-2023

7. Marking

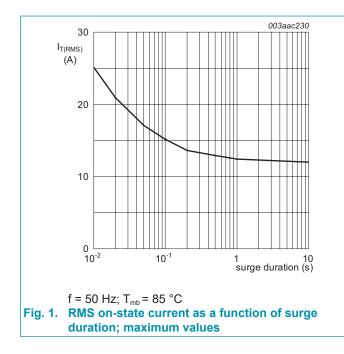
Table 4. Marking codes		
Type number	Marking codes	
	Assembly factory: A	Assembly factory: P
BT138Y-800E	BT138Y 800E	BT138Y 800E
	PJAxxxx xx	PJPxxxx xx

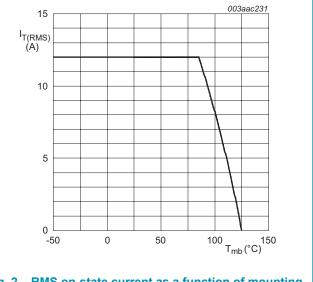
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

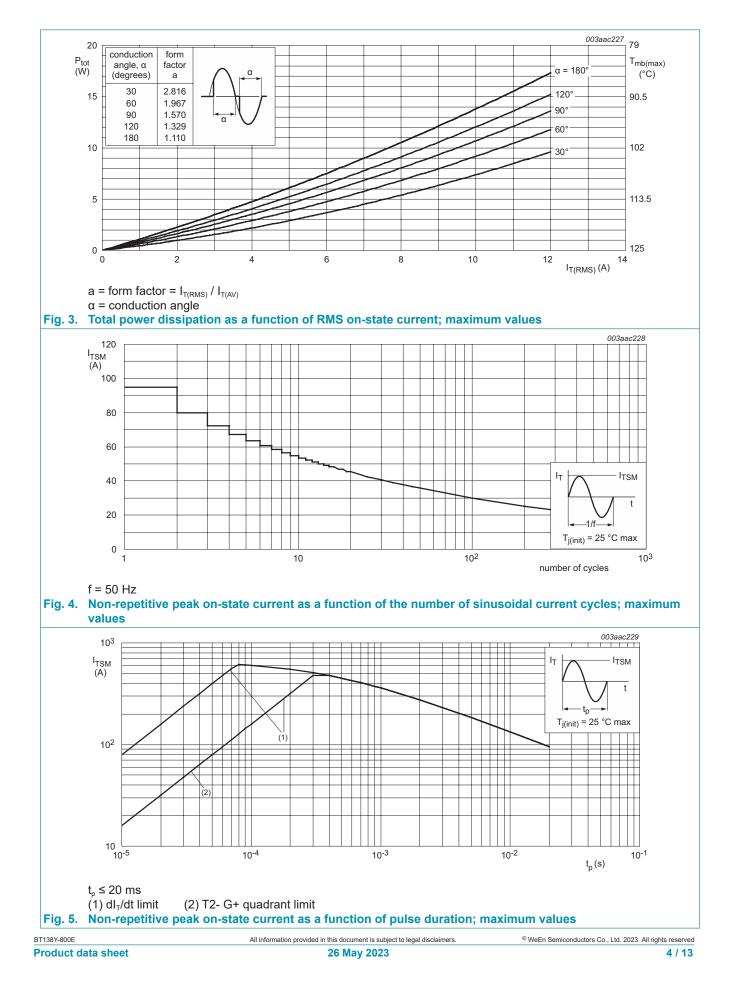
Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 85 °C; <u>Fig.1; Fig. 2</u> ; <u>Fig. 3</u>	-	12	A
I _{TSM} non-repetitive peak on- state current		full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4;</u> <u>Fig. 5</u>	-	95	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	105	А
l ² t	l ² t for fusing	t _p = 10 ms; sine wave pulse	-	45	A ² s
dl _T /dt	rate of rise of on-state current	I _G = 100 mA; T2+ G+	-	50	A/µs
		I _G = 100 mA; T2+ G-	-	50	A/µs
		I _G = 100 mA; T2- G-	-	50	A/µs
		I _G = 100 mA; T2- G+	-	10	A/µs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
T _j	junction temperature		-	125	°C





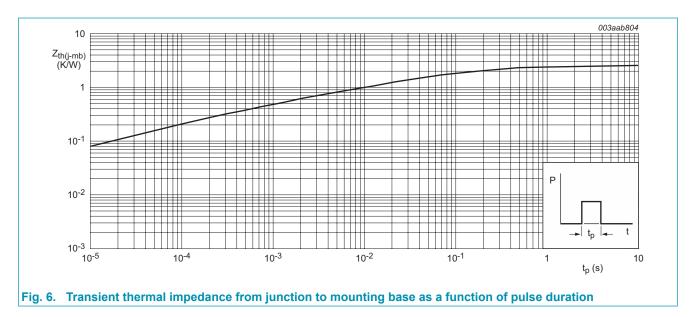


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9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	full cycle; <u>Fig. 6</u>	-	-	2.3	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W



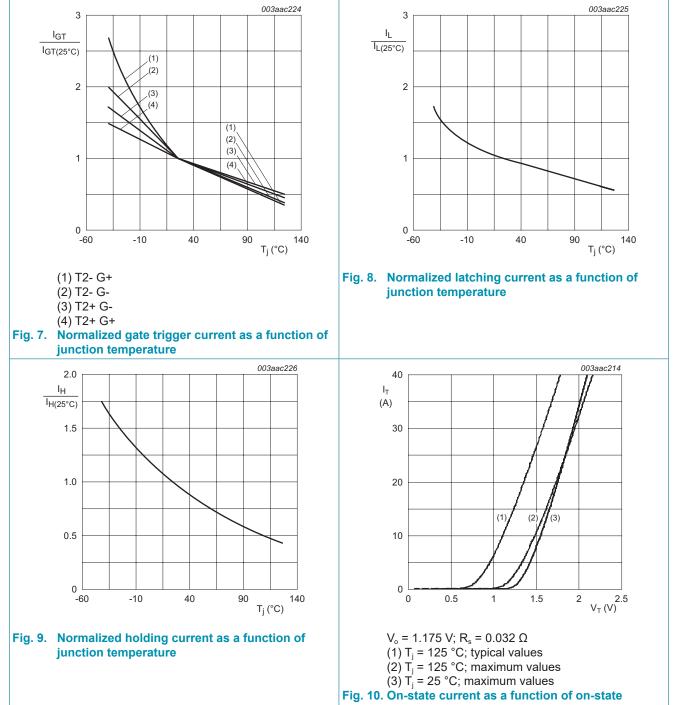
10. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from cathode to external heatsink	-	10	-	pF

11. Characteristics

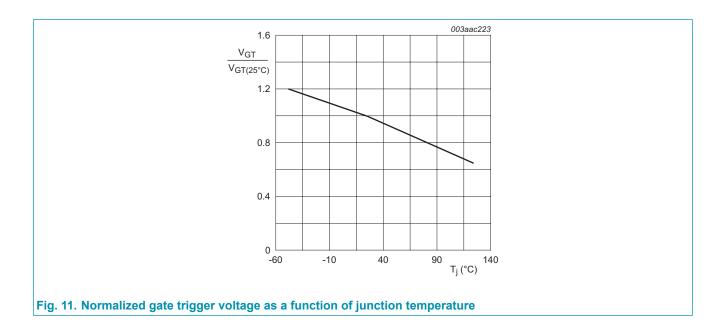
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
•	aracteristics	1				
I _{GT}	gate trigger current	$V_D = 12 V; I_T = 0.1 A; T2+ G+;$ $T_j = 25 °C; Fig. 7$	-	-	10	mA
		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G-};$ T _j = 25 °C; Fig. 7	-	-	10	mA
		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G-};$ T _j = 25 °C; Fig. 7	-	-	10	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2- G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	-	25	mA
l	latching current	$V_D = 12 \text{ V}; \text{ I}_G = 0.1 \text{ A}; \text{ T2+ } \text{ G+};$ $\text{T}_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	30	mA
		$V_D = 12 \text{ V}; \text{ I}_G = 0.1 \text{ A}; \text{ T2+ } \text{ G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	40	mA
		$V_D = 12 \text{ V}; \text{ I}_G = 0.1 \text{ A}; \text{ T2- } \text{ G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	30	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{G} = 0.1 \text{ A}; \text{ T2- G+};$ T ₁ = 25 °C; <u>Fig. 8</u>	-	-	40	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	30	mA
V _T	on-state voltage	I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.4	1.65	V
V _{GT}	gate trigger voltage	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{T}_j = 25 \text{ °C}$ Fig. 11	-	0.7	1	V
		$V_{\rm D}$ = 600V; I _T = 0.1 A;T _j = 150 °C	0.25	0.4	-	V
I _D	off-state current	$V_{\rm D} = 600 \text{ V}; \text{ T}_{\rm j} = 125 \text{ °C}$	-	0.1	0.5	μA
Dynamic	characteristics	· · · · · · · · · · · · · · · · · · ·	1			
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	-	50	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 16 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA};$ $dI_G/dt = 5 \text{ A}/\mu \text{s}$	-	2	-	A/ms

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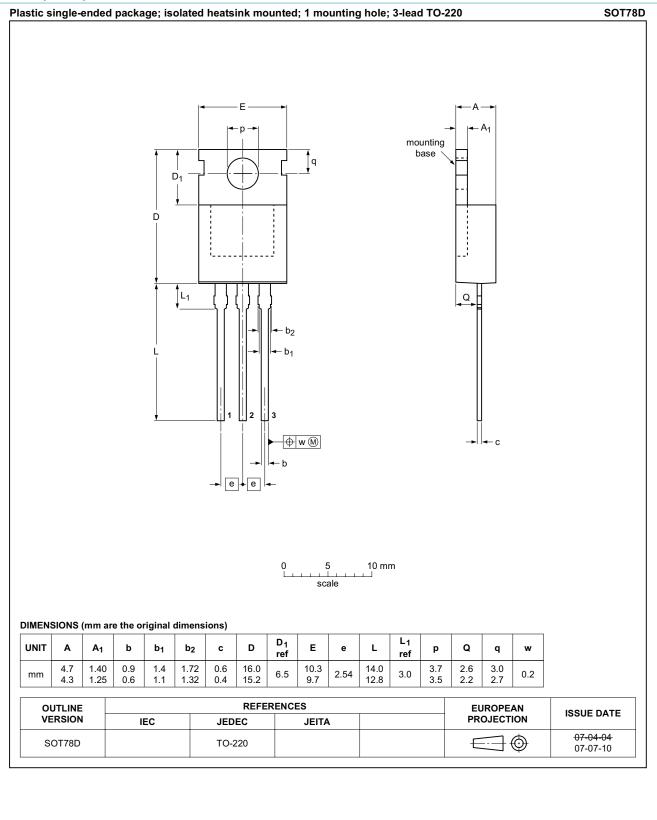
voltage

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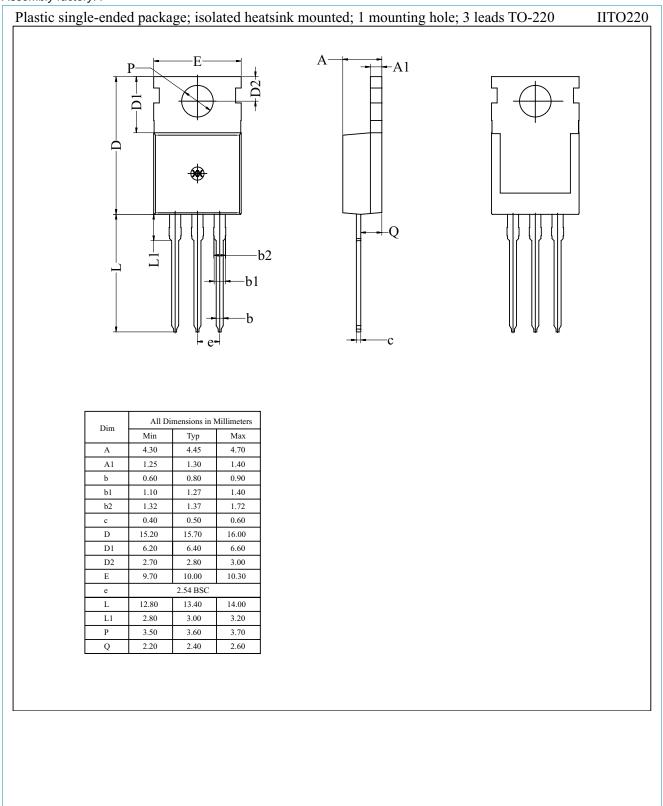


12. Package outline

Assembly factory: A



Assembly factory: P



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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